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1752-2 1.1 IPC Web Site for Information or http://www.ipc.org/IPC-175x					-1752 Standa					ration Class * 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat						
Sup	plier Information															
Con	npany Name *		Company Unique ID		Unique ID Authority			Response Date *			Response Document ID					
SEN	ITECH CORPORATIO	ОN	00-847-9941		DUNS			05-12								
Con	tact Name *		Title - Contact		Phone - Contact *			- Contact	t *		Dunlingto	Cantaat				
Susan McCooey			Customer/Document Control S		805-489-2111		smccooey@semtech.com			om	Duplicate	Contact	-> Autho	nzea Re	presentative	
Authorized Representativ		ve *	Title - Representative		Phone - Representative *		Email - Representative *			* Su	Supplier Comments or URL for Additional Information					
Susan McCooey			Customer/Document	Control S	805-489-2111			smccooey@semtech.com								
Requester Item Number		r (Mfr Item Number		Mfr Item Name	Effective Date Version Ma			Manufactu	uring Site	Weight *	UC	M	Unit Type		
			RClamp0504F.TCT		RailClamp® L	ow Capacitance T	-			China		6.455	mį)	Each	
	Alternate Recommend	ation						Alternate Item C			nents					
Ма	nufacturing Proces	ss In	formation													
Terminal Plating / Grid Array N		Materi	Naterial Terminal E		ase Alloy	J-STD-020 MSL Ra	ting	Peak Process Body Te		Temperatu	re Max Time at Peak Tempe		perature	ature Number of Reflow Cyc		
Matte Tin (Sn) Comments				Alloy 42		1				2 60 C	30 second		econds	3		
RC	lamp0504F.TCT is RI	EACH	-compliant product	, per EU R	egulation EC	C1907/2006 to inc	lude m	lost recer	nt additio	ons to the	SVHC can	didate list c	of subst	ances C	k SM	

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields
RoHS Materia	Composition Declar	ation				Declaration Type	* Detailed
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature						
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se		and the second s	town - town

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of	Tolerance		PPM
	Name		Material	Weight	Measure				oubstance outegory					Exempt	Weight	Measure	-	+	
+1 -1	l Die	+M -M	Doped silicon	0.2146	mg	+C	-C (Supplier		+S	-s	Si	7440-21-3		0.2146	mg			33,250
+1 -	Lead frame	+M -M	Alloy 42	1.9641	mg	+C	-C 8	Supplier		+S	-S	Fe	7439-89-6		1.1529	mg			178,61
						+C	-C [В		+S	-s	Nickel	7440-02-0		0.7982	mg			123,66
						+C	-C :	Supplier		+S	-s	Mn	7439-96-5		0.0094	mg			1,461
										+S	-s	Cr(not Cr6+)	7440-47-3		0.0012	mg			183
										+S	-s	Si	7440-21-3		0.0024	mg			365
		+M -M	Silver plating	0.0606	mg	+C	-C (Supplier		+S	-s	Ag	7440-22-4		0.0606	mg			9,396
+ -	Bonding wire	+M -M	Cu	0.0146	mg	+C	-C :	Supplier		+S	-s	Cu	7440-50-8		0.0146	mg			2,268
+1 -1	Molding compound	1+M -M	CEL-1702HF	3.7179	mg	+C	-C :	Supplier		+S	-s	Amorphous silica1	60676-86-0		2.9371	mg			455,03
				1						+S	-s	Amorphous silica2	7631-86-9		0.2974	mg			46,079
										+S	-s	Epoxy Resin 1	Proprietary		0.1859	mg			28,799
										+S	-s	Epoxy Resin 2	Proprietary		0.0744	mg			11,520
										+S	-s	Hardener	Proprietary		0.1859	mg			28,799
										+S	-s	Catalyst	Proprietary		0.0297	mg			4,608
										+S	-s	Carbon black	133-86-4		0.0074	mg			1,152
+1 -	Die attached epoxy	/ +M -M	84-1LMISR4	0.0864	mg	+C	-C (Supplier		+S	-s	Silver	7440-22-4		0.0725	mg			11,240
L			a	1	I				1	+S	-s	bisphenol-F-(epichlorhy	9003-36-5		0.013	mg		4	2,007
										+S	-s	1,4-bis(2,3 epoxypropo	2425-79-8		0.0004	mg			67
										+S	-s	dapsone	80-08-0		0.0004	mg			67
+ -	I Tin solder	+M -M	Pure Tin	0.3965	mg	+C	-C (Supplier		+S	-s	Sn	7440-31-5		0.3965	mg			61,434